



Docket No.: H0498.70155US00  
(PATENT)

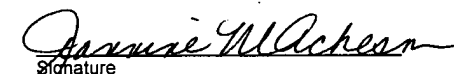
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hong Yang et al.  
Serial No.: 09/940072  
Confirmation No.: 3068  
Filed: August 27, 2001  
For: FABRICATION OF CERAMIC MICROSTRUCTURES  
Examiner: Carlos Lopez  
Art Unit: 1731

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I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as First Class Mail, in an envelope addressed to: Mail Stop RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: 1-24-06

  
Signature

**AMENDMENT AFTER FINAL ACTION UNDER 37 C.F.R. 1.116**

**MS RCE**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Final Office Action dated July 24, 2005, please amend the above-identified U.S. patent application as follows:

**The Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 9 of this paper.